

## Features

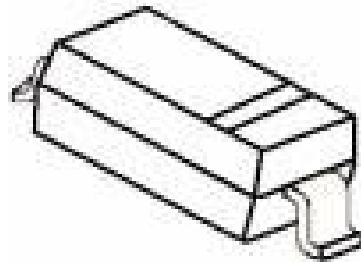
SOD-323

Low reverse leakage

Fast Switching Device (TRR &lt;4.0 nS)

Power Dissipation of 200mW

High Stability and High Reliability



## Mechanical Data

Cases:SOD-323 Small Outline Plastic Package

Polarity: Color band denotes cathode end

MARKING: T4

Mounting Position: Any

## Maximum Ratings & Thermal Characteristics

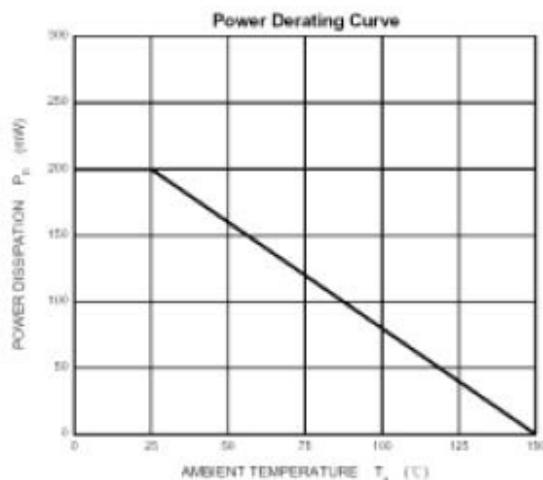
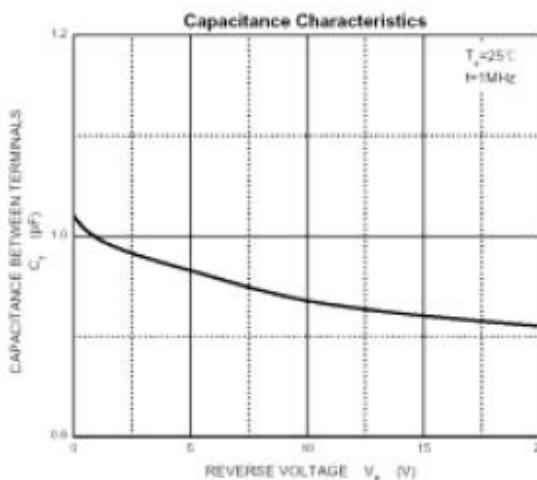
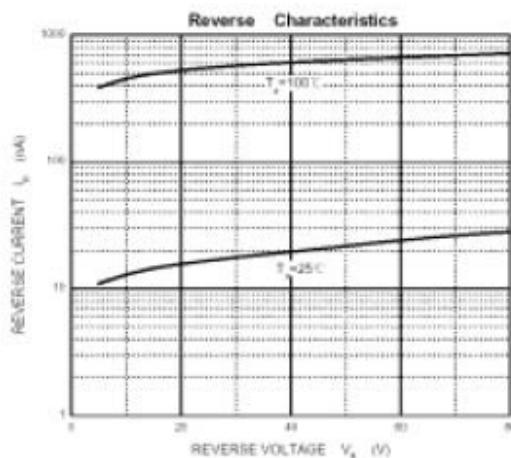
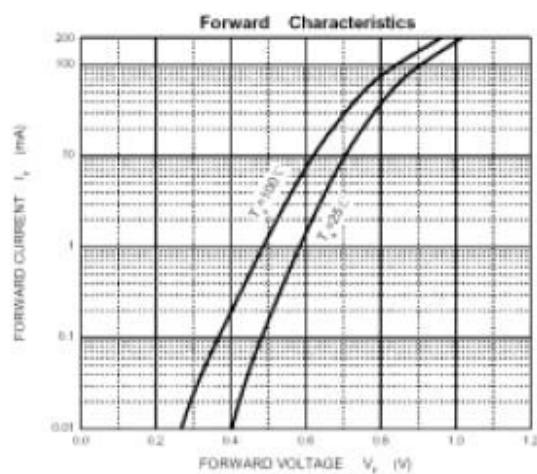
(Ratings at 25°C ambient temperature unless otherwise specified.)

Parameters	Symbol	Value	Unit
Reverse Voltage	V <sub>R</sub>	75	V
Peak Reverse Voltage	V <sub>RM</sub>	100	V
Power Dissipation	P <sub>d</sub>	200	mW
Operating junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>s</sub>	-65-+150	°C
Working Inverse Voltage	W <sub>IV</sub>	75	V
Average Rectified Current	I <sub>o</sub>	150	mA
Non-repetitive Peak Forward Current	I <sub>FM</sub>	300	mA
Peak Forward Surge Current @ tp=1us; TA=25°C	I <sub>FSM</sub>	2.0	A

## Electrical Characteristics

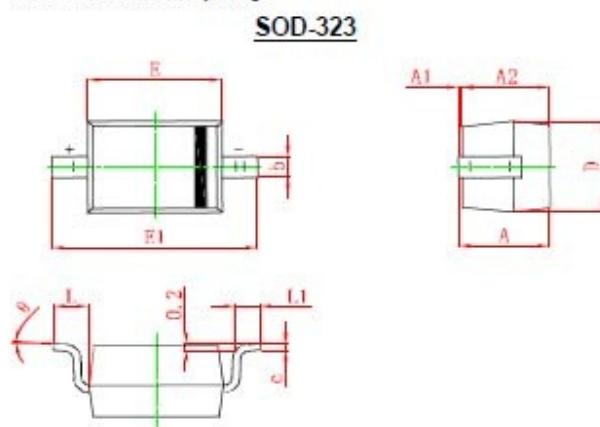
 (Ratings at 25°C ambient temperature unless otherwise specified).

Symbols	Parameter	Test Condition	Limits		Unit
			Min	Max	
BV	Breakdown Voltage	I <sub>R</sub> =100uA I <sub>R</sub> =5uA	100 75		V
IR	Reverse Leakage Current	VR=20V VR=75	---	25 1	nA uA
V	Forward Voltage	I <sub>F</sub> =1.0mA I <sub>F</sub> =10mA I <sub>F</sub> =50mA I <sub>F</sub> =150mA	---	0.715 0.855 1.00 1.25	V
TRR	Reverse Recovery Time	I <sub>F</sub> = IR=10mA RL=100Ω IRR=0.1 X IR	---	4	nS
CT	Capacitance	VR=0V, f=1MHZ	---	2	pF



### SOD-323 PACKAGE OUTLINE

Plastic surface mounted package



Symbol	Min.(mm)	Max.(mm)
A		1.000
A1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
c	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
L	0.475REF	
L1	0.250	0.400
θ	0°	8°